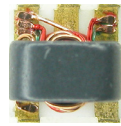


# Surface Mount RF Transformer

75Ω

0.3 to 475 MHz

TC9-1-75G2+



CASE STYLE: AT224-3

## Maximum Ratings

Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

## Pin Connections

PRIMARY DOT	6
PRIMARY	3
SECONDARY DOT	1
SECONDARY	3

## Features

- suitable for tin/lead and RoHS solder systems
- wideband, 0.3 to 475 MHz
- good return loss, 23 dB typ. in 1 dB bandwidth
- step-down 9:1 autotransformer
- aqueous washable

## Applications

- matching laser diode

### +RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



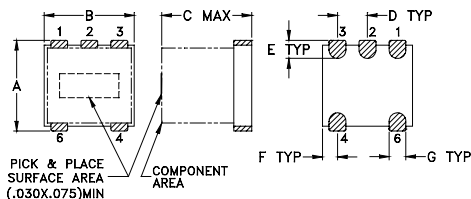
Available Tape and Reel at no extra cost	
Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500
13"	1000, 2000

## Transformer Electrical Specifications

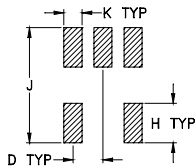
Ω RATIO (Primary/Secondary)	FREQUENCY (MHz)	INSERTION LOSS*		
		3 dB MHz	2 dB MHz	1 dB MHz
75/8	0.3-475	0.3-475	0.5-450	0.9-370

\* Insertion Loss is referenced to mid-band loss, 0.4 dB typ.  
Stepdown, 75 ohm primary, 51 pF across secondary

## Outline Drawing AT224-3



### PCB Land Pattern



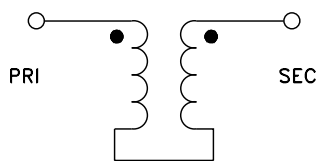
Suggested Layout,  
Tolerance to be within ±.002

## Outline Dimensions (inch)

A	B	C	D	E	F
.150	.150	.150	.050	.030	.025
3.81	3.81	3.81	1.27	0.76	0.64
G	H	J	K	wt	
.028	.065	.190	.030	grams	
0.71	1.65	4.83	0.76	0.10	

Demo Board MCL P/N: TB-276

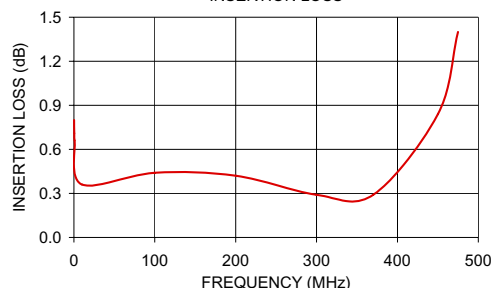
### Config. D



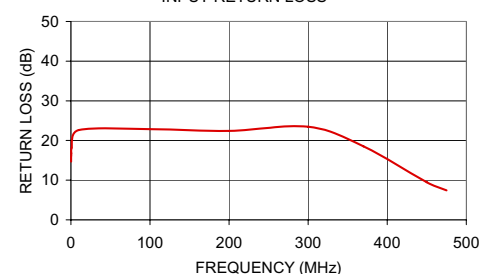
## Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.30	0.80	14.70
0.50	0.71	16.80
0.90	0.66	18.13
10.00	0.36	22.63
100.00	0.44	22.86
200.00	0.42	22.40
300.00	0.29	23.48
370.00	0.29	18.53
450.00	0.84	9.48
475.00	1.40	7.44

TC9-1-75G2+  
INSERTION LOSS



TC9-1-75G2+  
INPUT RETURN LOSS



### Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.  
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.  
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at [www.minicircuits.com/MCLStore/terms.jsp](http://www.minicircuits.com/MCLStore/terms.jsp)



[www.minicircuits.com](http://www.minicircuits.com) P.O. Box 350166, Brooklyn, NY 11235-0003 (718) 934-4500 [sales@minicircuits.com](mailto:sales@minicircuits.com)

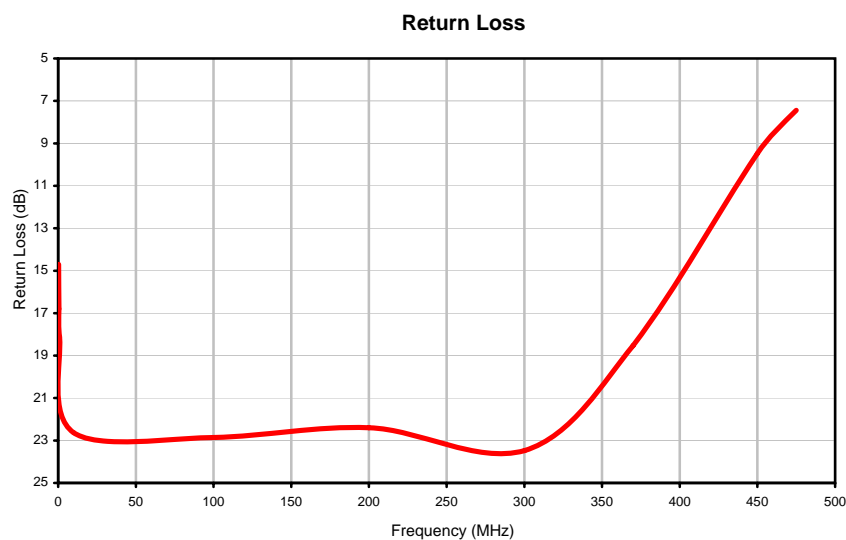
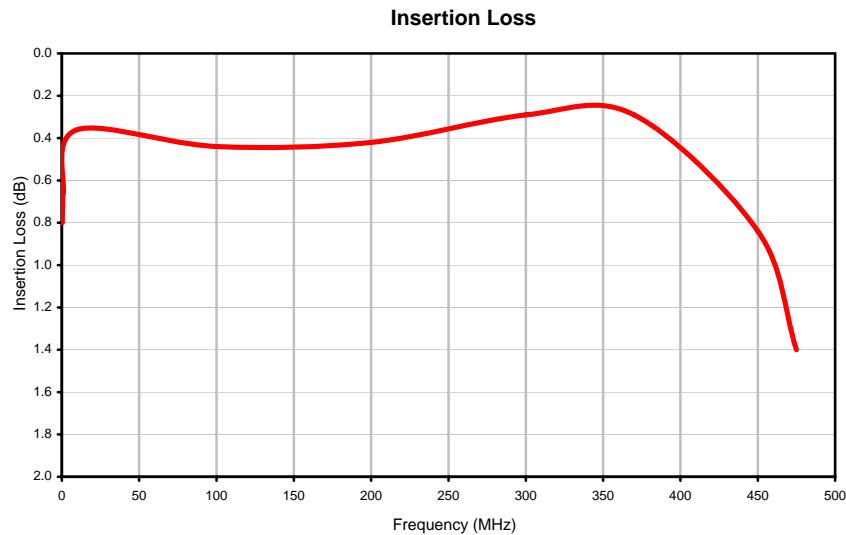
REV. B  
M151107  
TC9-1-75G2+  
IG/TD/CP/AM  
151019  
Page 1 of 1

---

*Typical Performance Data*

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.30	0.80	14.70
0.50	0.71	16.80
0.90	0.66	18.13
10.00	0.36	22.63
100.00	0.44	22.86
200.00	0.42	22.40
300.00	0.29	23.48
370.00	0.29	18.53
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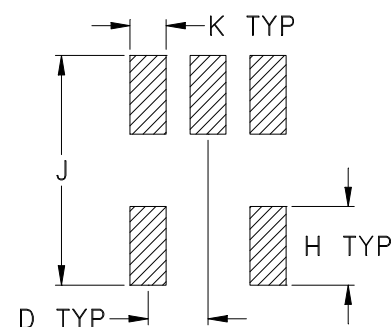
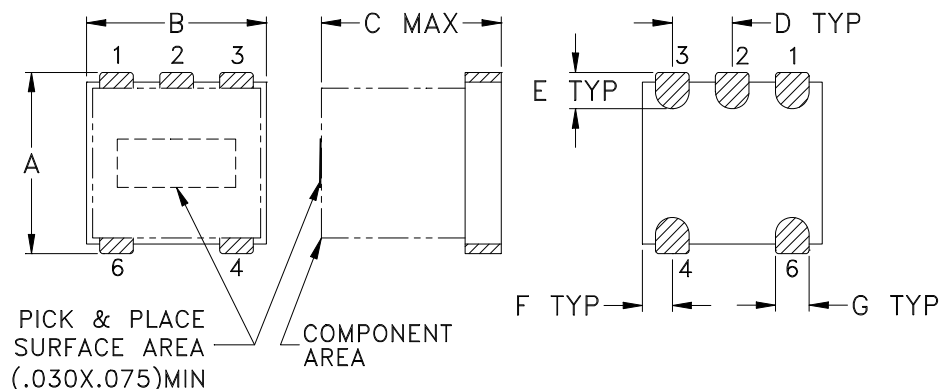
## Typical Performance Curves



## Outline Dimensions

AT224-3

## PCB Land Pattern



Suggested Layout,  
Tolerance to be within  $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT224-3	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	-- --	.10

Dimensions are in inches (mm). Tolerances: 2 Pl.  $\pm .01$ ; 3 Pl.  $\pm .005$

### Notes:

- Open style, ceramic base.
- Termination finish: 3.15-5.12  $\mu$  inch (.08-.130 microns) Gold over 78-236  $\mu$  inch (1.98-6.0 microns) Nickel plate.



P.O. Box 350186, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

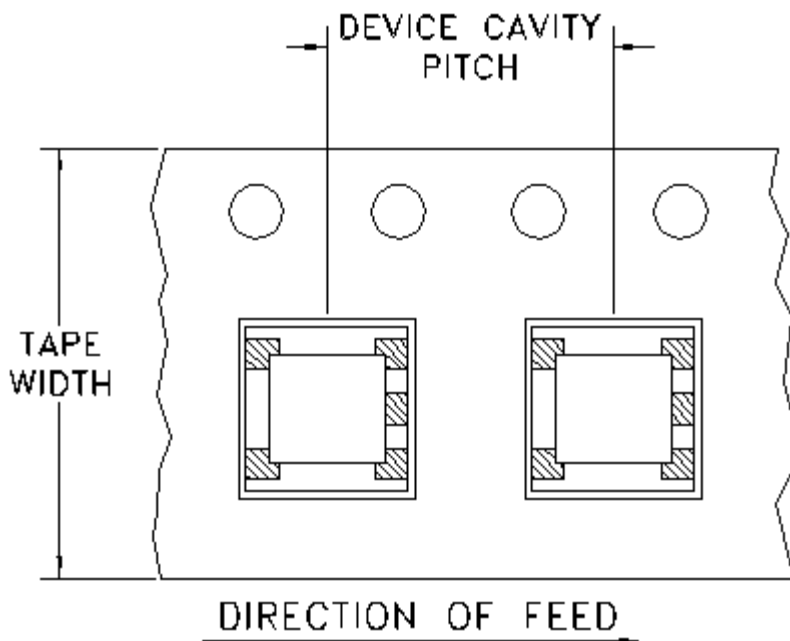


The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: [www.minicircuits.com](http://www.minicircuits.com)

RF/IF MICROWAVE COMPONENTS

# Tape & Reel Packaging TR-F17

## DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: [www.minicircuits.com/pages/pdfs/tape.pdf](http://www.minicircuits.com/pages/pdfs/tape.pdf)



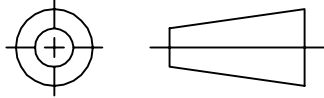
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

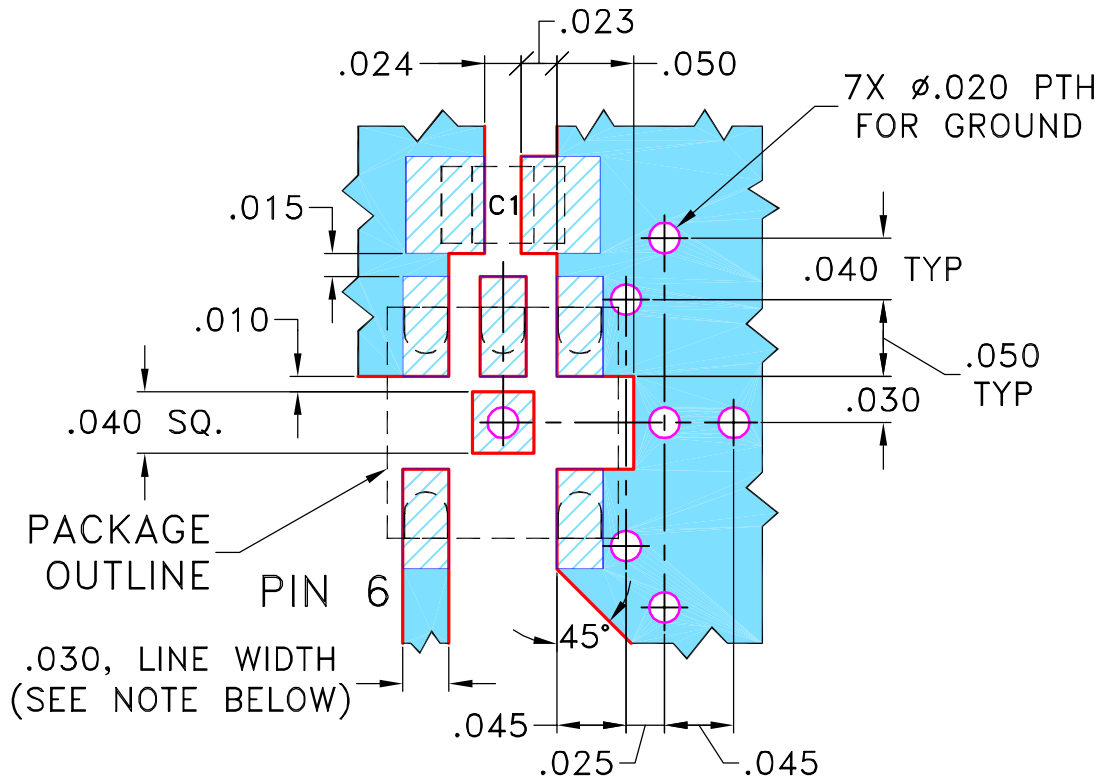
## THIRD ANGLE PROJECTION



## REVISIONS

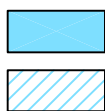
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M91565	NEW RELEASE	04/16/04	AV	IG
A	M102713	ADDED "...WITH SMOBC"	01/12/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION  
FOR AT224 CASE STYLE, "pp/kp" PIN CONNECTION



CAPACITOR C1: 0805 SIZE, FOR VALUE SEE CATALOG.

- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030"  $\pm$  .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



SOLID BLUE RECTANGLE DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DIAGONAL HATCHED BLUE RECTANGLE DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:  
 2 PL DECIMALS  $\pm$   
 3 PL DECIMALS  $\pm$  .005  
 ANGLES  $\pm$   
 FRACTIONS  $\pm$

DRAWN

AV

03/23/04

CHECKED

IL

04/16/04

APPROVED

IG

04/16/04

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ASHEETA1.DWG REV:A DATE:01/12/95



**Mini-Circuits®** 13 Neptune Avenue  
 Brooklyn NY 11235

PL, pp/kp, 75, AT224, TC9, TB-276

SIZE  
A

CODE IDENT  
15542

DRAWING NO:  
98-PL-155

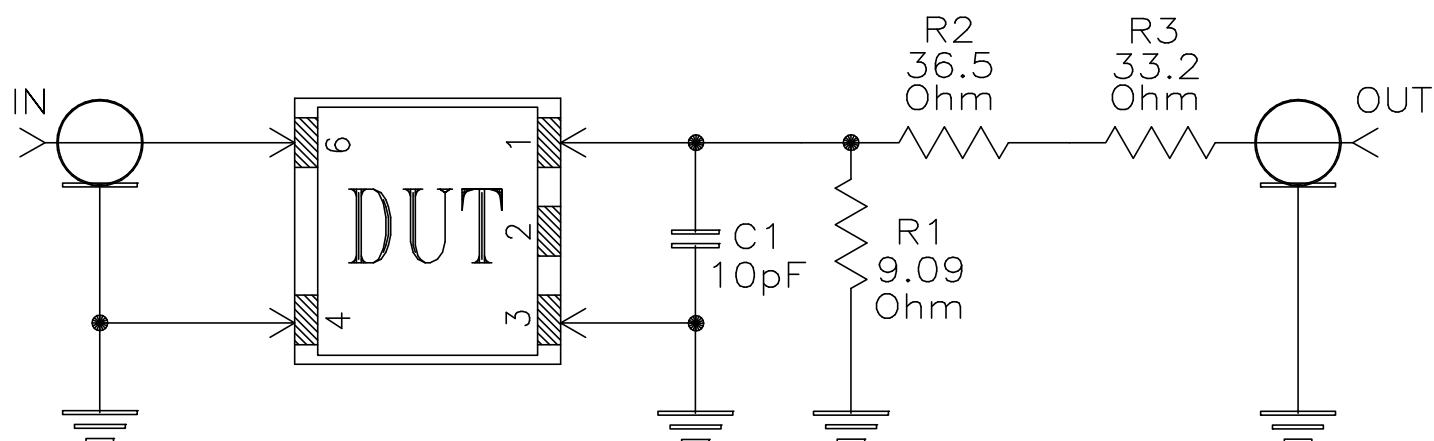
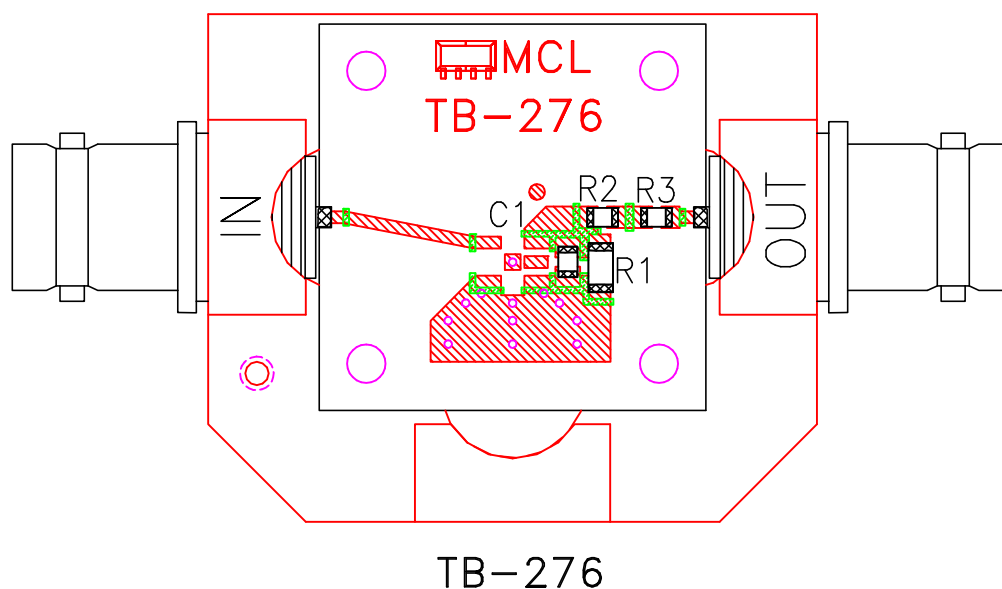
REV:  
A

FILE: 98PL155

SCALE: 8:1

SHEET: 1 OF 1


# Evaluation Board and Circuit



Schematic Diagram

## Notes:

1. BNC Female connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215